

Product Summary

V _{BR} (Min)	I _{PP} (Max)	C _{I/O} (Typ)
6V	5.5A	0.55pF

Description

The DT1240V3-04LP is a high-performance device suitable for protecting four high speed I/Os. These devices are assembled in U-DFN2510-10 package and have high ESD surge capability and low capacitance.

Applications

Typically used at high-speed ports such as USB 2.0, IEEE1394 (Firewire®, iLink), Serial ATA, DVI, HDMI™, PCI™.

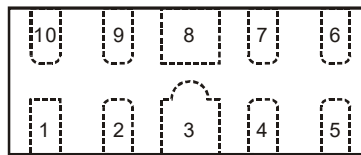
Features

- Clamping Voltage: 8.8V at 10A 100ns, TLP 9V at 5.5A 8μs/20μs
- IEC 61000-4-2 (ESD): Air — ±16kV, Contact — ±14kV
- IEC 61000-4-5 (Lightning): ±5.5A (8/20μs)
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 0.55pF Typical
- TLP Dynamic Resistance: 0.3Ω
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative.**
<https://www.diodes.com/quality/product-definitions/>

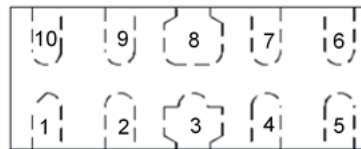
Mechanical Data

- Package: U-DFN2510-10
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals:
 - Sites1 and 2: Finish – NiPdAu over Copper Leadframe. Solderable per MIL-STD 202, Method 208④
 - Site 3: Matte Tin over Copper Leadframe. Solderable per MIL-STD-202, Method 208③
- Weight: 0.004 grams (Approximate)

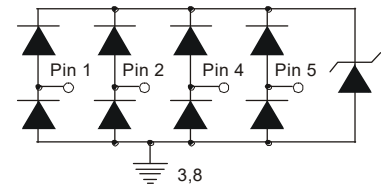
Sites 1 and 2: U-DFN2510-10



Site 3: U-DFN2510-10 (Type CJ)



Pin Description (Top View)



Device Schematic

Ordering Information (Note 4)

Orderable Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
DT1240V3-04LP-7	U-DFN2510-10	BE7	7	8	3,000	Tape & Reel
DT1240V3-04LP-7	U-DFN2510-10 (Type CJ)	BE7	7	8	3,000	Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 - See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

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Marking Information

BE7 YM

BE7 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: N = 2026)
M = Month (ex: 9 = September)

QE5 YWX

QE5 = Product Type Marking Code
YWX = Date Code Marking
Y = Year (ex: 6 = 2026)
W = Week
(ex: a = Week 27; z Represents Week 52 and 53)
X = Internal Code (ex: U = Monday)

Date Code for YM

Year	2015	-	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035
Code	C	-	N	P	R	S	T	U	V	W	X	Y

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Date Code Key for YWX

Year	2015	-	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035
Code	5	-	6	7	8	9	0	1	2	3	4	5

Week	1-26	27-52	53
Code	A-Z	a-z	z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Y	Z

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	I _{PP}	5.5	A	I/O to V _{SS} , 8/20μs
Peak Pulse Power, per IEC 61000-4-5	P _{PP}	60	W	I/O to V _{SS} , 8/20μs
ESD Protection – Contact Discharge, per IEC 61000-4-2	V _{ESD_CONTACT}	±14	kV	I/O to V _{SS}
ESD Protection – Air Discharge, per IEC 61000-4-2	V _{ESD_AIR}	±16	kV	I/O to V _{SS}
Operating & Storage Temperature Range	T _{OP} , T _{STG}	-55 to +150	°C	—

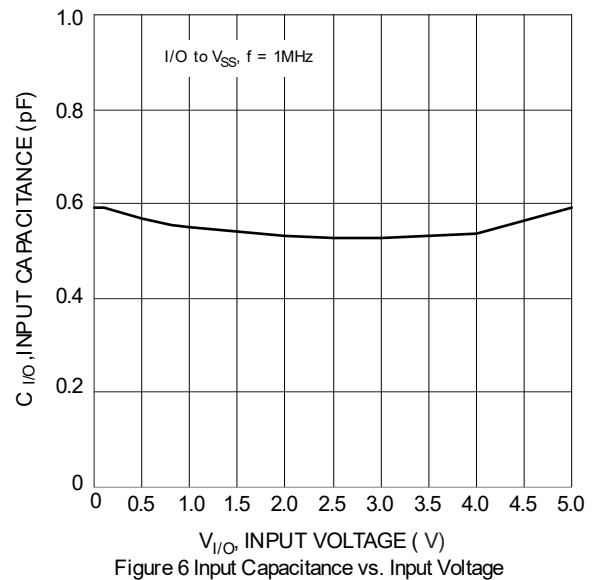
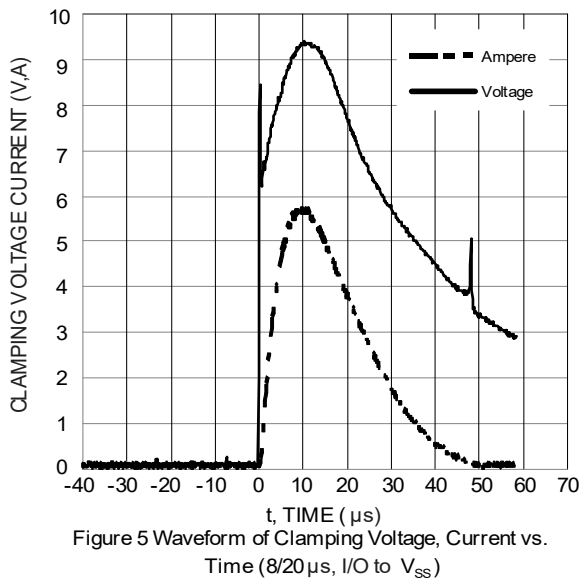
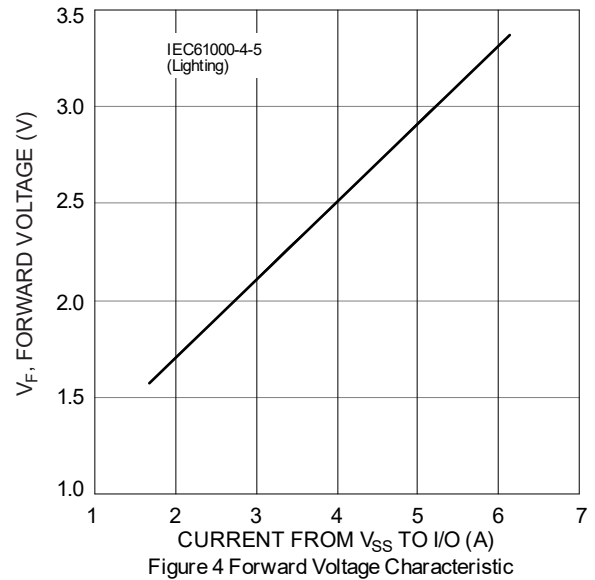
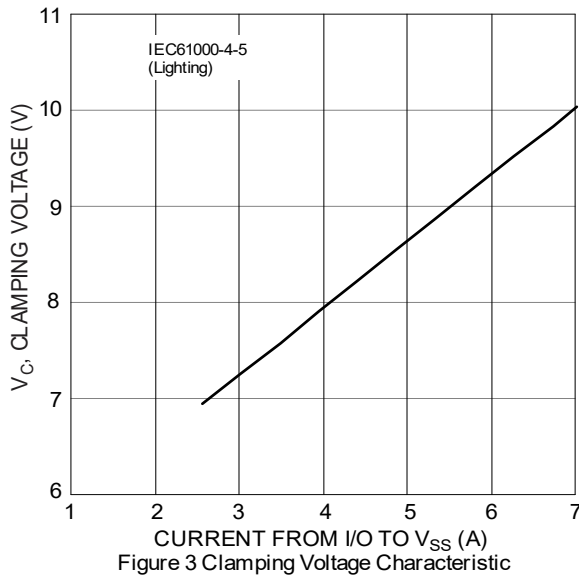
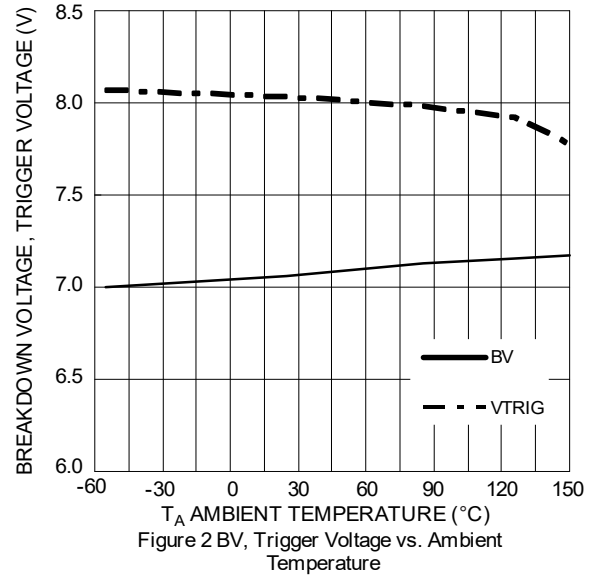
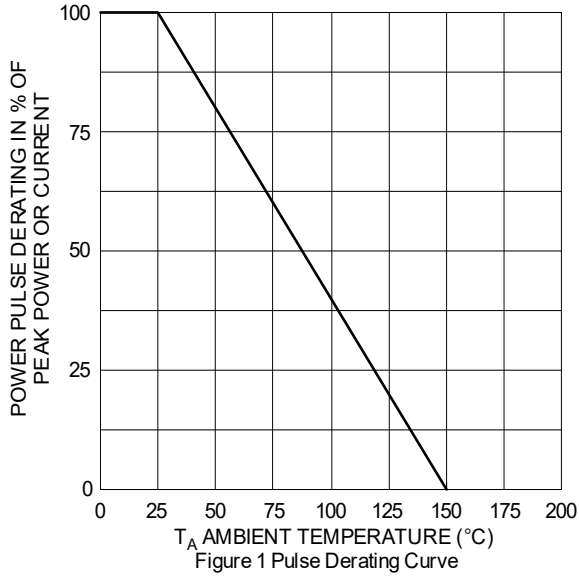
Thermal Characteristics

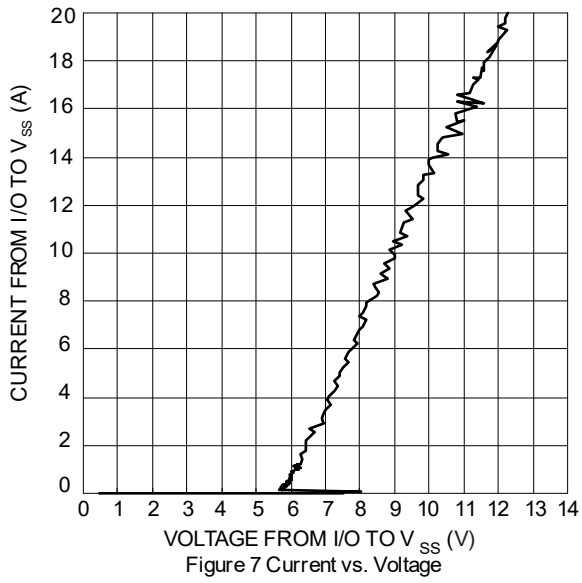
Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	P _D	350	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	R _{θJA}	360	°C/W

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	—	—	3.3	V	—
Reverse Current	I _R	—	—	0.5	μA	V _R = 3.3V, I/O to V _{SS}
Reverse Breakdown Voltage	V _{BR}	6	—	—	V	I _R = 1mA, I/O to V _{SS}
Forward Clamping Voltage	V _F	-1.0	-0.85	—	V	I _F = -15mA, I/O to V _{SS}
Reverse Clamping Voltage (Note 6)	V _C	—	9	11	V	I _{PP} = 5.5A, I/O to V _{SS} , 8/20μs
Trigger Voltage	V _{TRIG}	—	—	9.5	V	—
ESD Clamping Voltage	V _{ESD}	—	8.8	—	V	TLP, 10A, t _P = 100ns, I/O to V _{SS}
Dynamic Reverse Resistance	R _{DIF-R}	—	0.3	—	Ω	TLP, 10A, t _P = 100ns, I/O to V _{SS}
Dynamic Forward Resistance	R _{DIF-F}	—	0.25	—	Ω	TLP, 10A, t _P = 100ns, V _{SS} to I/O
Channel Input Capacitance (Note 7)	C _{I/O}	—	0.55	0.65	pF	V _{I/O} = 2.5V, V _{SS} = 0, f = 1MHz
Delta C _{I/O}	C _{I/OMAX} -C _{I/OMIN}	—	0.04	—	pF	C _{I/OMAX} -C _{I/OMIN}

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 - Clamping voltage value is based on an 8 x 20μs peak pulse current (I_{PP}) waveform.
 - C_{I/O1} = C_{PIN1} + C_{PIN10}; C_{I/O2} = C_{PIN2} + C_{PIN9}; C_{I/O3} = C_{PIN4} + C_{PIN7}; C_{I/O4} = C_{PIN5} + C_{PIN6}.



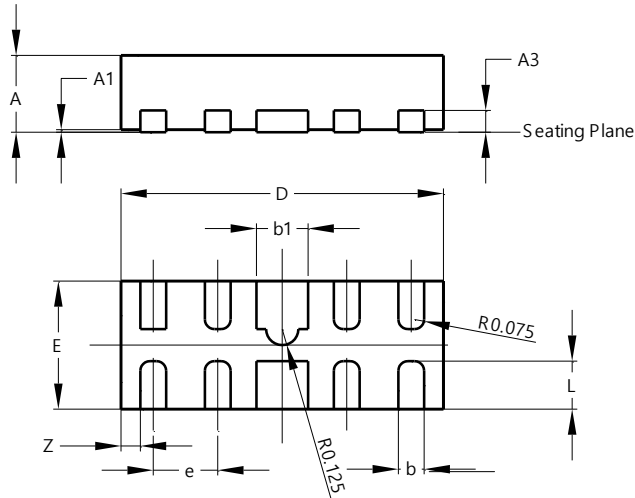


Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

Package Type One (Sites 1 and 2):

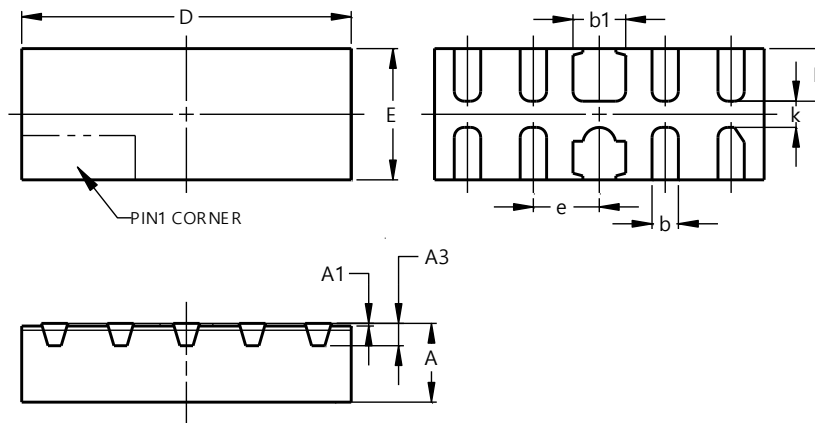
U-DFN2510-10



U-DFN2510-10			
Dim	Min	Max	Typ
A	0.545	0.605	0.575
A1	0.00	0.05	0.03
A3	-	-	0.13
b	0.15	0.25	0.20
b1	0.35	0.45	0.40
D	2.450	2.575	2.500
e	-	-	0.50
E	0.950	1.075	1.000
L	0.325	0.425	0.375
z	-	-	0.150
All Dimensions in mm			

Package Type Two (Site 3):

U-DFN2510-10 (Type CJ)



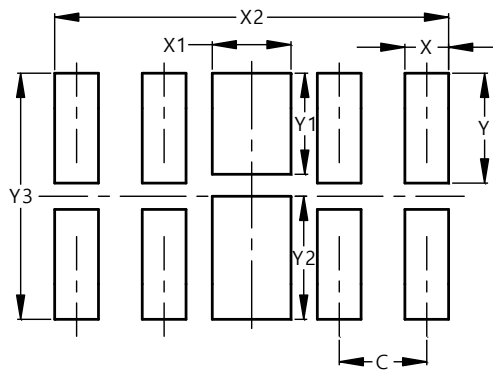
U-DFN2510-10 (Type CJ)			
Dim	Min	Max	Typ
A	0.545	0.605	--
A1	0.00	0.05	--
A3	0.152REF		
b	0.150	0.250	--
b1	0.350	0.450	--
D	2.450	2.575	--
E	0.950	1.075	--
e	--	--	0.500
E	0.950	1.075	1.000
L	0.350	0.450	--
k	0.200REF		
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

Package Type One (Sites 1 and 2):

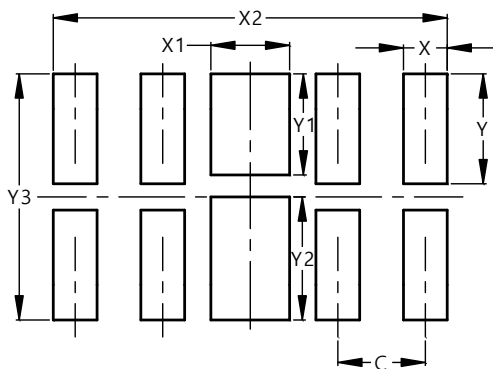
U-DFN2510-10



Dimensions	Value (in mm)
C	0.500
X	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1.400

Package Type Two (Site 3):

U-DFN2510-10 (Type CJ)



Dimensions	Value (in mm)
C	0.500
X	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1.400

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